# **ECOSPARK®** Ignition IGBT

# 300 mJ, 400 V, N-Channel Ignition IGBT

#### **Features**

- SCIS Energy = 300 mJ at  $T_J = 25$ °C
- Logic Level Gate Drive
- This Device is Pb-Free and is RoHS Compliant
- AEC-Q101 Qualified and PPAP Capable

#### **Applications**

- Automotive Ignition Coil Driver Circuits
- High Current Ignition System
- Coil on Plug Applications

# **MAXIMUM RATINGS** ( $T_J = 25^{\circ}C$ Unless Otherwise Stated)

Parameter	Symbol	Value	Units
Collector to Emitter Breakdown Voltage (I <sub>C</sub> = 1 mA)	BV <sub>CER</sub>	400	V
Emitter to Collector Voltage - Reverse Battery Condition (I <sub>C</sub> = 10 mA)	BV <sub>ECS</sub>	24	V
ISCIS = 14.2 A, L = 3.0 mHz, R <sub>GE</sub> = 1 K $\Omega$ (Note 1), T <sub>C</sub> = 25°C	E <sub>SCIS25</sub>	300	mJ
$\begin{array}{l} \text{ISCIS} = 10.6 \text{ A, L} = 3.0 \text{ mHz,} \\ \text{R}_{\text{GE}} = 1 \text{ K}\Omega \text{ (Note 2), T}_{\text{C}} = 150^{\circ}\text{C} \end{array}$	E <sub>SCIS150</sub>	170	mJ
Collector Current Continuous, at V <sub>GE</sub> = 4.0 V, T <sub>C</sub> = 25°C	IC25	21	Α
Collector Current Continuous, at V <sub>GE</sub> = 4.0 V, T <sub>C</sub> = 110°C	IC110	17	Α
Gate to Emitter Voltage Continuous	$V_{GEM}$	±10	V
Power Dissipation Total, T <sub>C</sub> = 25°C	PD	150	W
Power Dissipation Derating, T <sub>C</sub> > 25°C	PD	1	W/°C
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>STG</sub>	–55 to 175	°C
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	TL	300	°C
Reflow soldering according to JESD020C	T <sub>PKG</sub>	260	°C
HBM-Electrostatic Discharge Voltage at100 pF, 1500 Ω	ESD	4	kV
CDM–Electrostatic Discharge Voltage at 1 $\Omega$	ESD	2	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

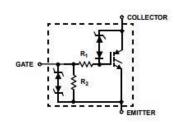
- Self Clamped inductive Switching Energy (ESCIS25) of 300 mJ is based on the test conditions that is starting T<sub>J</sub> = 25°C, L = 3 mHz, ISCIS = 14.2 A, V<sub>CC</sub> = 100 V during inductor charging and V<sub>CC</sub> = 0 V during time in clamp.
- 2. Self Clamped inductive Switching Energy (ESCIS150) of 170 mJ is based on the test conditions that is starting  $T_J = 150^{\circ}C$ , L = 3 mHz, ISCIS = 10.6 A,  $V_{CC} = 100$  V during inductor charging and  $V_{CC} = 0$  V during time in clamp.

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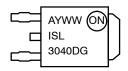
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DPAK (SINGLE GAUGE) CASE 369C

#### MARKING DIAGRAM



ISL3040DG = Device Code A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### THERMAL RESISTANCE RATINGS

Characteristic	Symbol	Max	Units
Junction-to-Case - Steady State (Drain) (Notes 1, 3 and 4)	$R_{ heta JC}$	1	°C/W

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C Unless Otherwise Specified)

Collector to Emitter Breakdown Voltage $\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Unit	Max	Тур	Min	Test Condition		Symbol	Parameter
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$								OFF CHARACTERISTICS
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V	430	400	370	$R_{GE} = 1 K\Omega$		BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage
$ T_{J} = 25^{\circ}C                                    $	V	450	420	390	R <sub>GE</sub> = 0,		BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V	-	-	30			BV <sub>ECS</sub>	Emitter to Collector Breakdown Voltage
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V	-	±14	±12		I <sub>GES</sub> = ±2 mA	$BV_{GES}$	Gate to Emitter Breakdown Voltage
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	μΑ	25	-	-	T <sub>J</sub> = 25°C		I <sub>CER</sub>	Collector to Emitter Leakage Current
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	mA	1	-	-	T <sub>J</sub> = 150°C	HGE = 1 K22		
Series Gate Resistance $R_1$ $ 70$ $-$ Gate to Emitter Resistance $R_2$ $10 \text{ K}$ $ 26 \text{ K}$ ON CHARACTERISTICS  Collector to Emitter Saturation Voltage $V_{CE(SAT)}$ $V_{CE(S$	mΑ	1	_	_	$T_J = 25^{\circ}C$	V <sub>EC</sub> = 24 V	I <sub>ECS</sub>	Emitter to Collector Leakage Current
Gate to Emitter Resistance $R_2$ $10 \text{ K}$ $ 26 \text{ K}$ ON CHARACTERISTICS  Collector to Emitter Saturation Voltage $V_{CE(SAT)}$ $V_{CE(S$		40	-	-	T <sub>J</sub> = 150°C			
Collector to Emitter Saturation Voltage $V_{CE(SAT)}$ $V_$	Ω	-	70	-			R <sub>1</sub>	Series Gate Resistance
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Ω	26 K	-	10 K			R <sub>2</sub>	Gate to Emitter Resistance
Collector to Emitter Saturation Voltage $V_{CE(SAT)}$ $I_{CE} = 10 \text{ A}, V_{GE} = 4.5 \text{ V}$ $ 1.58$ $1.80$ $ 1.58$ $1.80$ $  1.58$ $         -$								ON CHARACTERISTICS
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V	1.65	1.25	-			V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V	1.80	1.58	-	I <sub>CE</sub> = 10 A, V <sub>GE</sub> = 4.5 V T <sub>J</sub> = 150°C		V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V	2.20	1.90	-			V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage
				•				OYNAMIC CHARACTERISTICS
$V_{CE} = V_{GE} \qquad T_{J} = 150^{\circ}C \qquad 0.75 \qquad - \qquad 1.8$ Gate to Emitter Plateau Voltage $V_{GEP} \qquad V_{CE} = 12 \text{ V, } I_{CE} = 10 \text{ A} \qquad - \qquad 3.0 \qquad - \qquad $	nC	-	17	-	I <sub>CE</sub> = 10 A, V <sub>CE</sub> = 12 V, V <sub>GE</sub> = 5 V		Q <sub>G(ON)</sub>	Gate Charge
Gate to Emitter Plateau Voltage	V	2.2	_	1.3	T <sub>J</sub> = 25°C	I <sub>CE</sub> = 1 mA,	V <sub>GE(TH)</sub>	Gate to Emitter Threshold Voltage
		1.8	_	0.75	T <sub>J</sub> = 150°C	$v_{CE} = v_{GE}$ $T_J = 150^{\circ}C$		
CW/TOUING CHARACTERISTICS	V	-	3.0	-	V <sub>CE</sub> = 12 V, I <sub>CE</sub> = 10 A		$V_{GEP}$	Gate to Emitter Plateau Voltage
WITCHING CHARACTERISTICS								SWITCHING CHARACTERISTICS
Current Turn–On Delay Time–Resistive $td_{(ON)R}$ $V_{CE} = 14 \text{ V}, R_L = 1 \Omega$ – 0.7 4	μS	4	0.7	-	$V_{CE}$ = 14 V, $R_{L}$ = 1 $\Omega$ $V_{GE}$ = 5 V, $R_{G}$ = 470 $\Omega$ $T_{J}$ = 25°C		td <sub>(ON)R</sub>	Current Turn-On Delay Time-Resistive
		7	2.1	-			t <sub>rR</sub>	Current Rise Time-Resistive
Current Turn-Off Delay Time-Inductive td <sub>(OFF)L</sub> V <sub>CE</sub> = 300 V, L = 1 mH, - 4.8 15		15	4.8	-	,	V <sub>CE</sub> = 300 V, L = 1 mH,	td <sub>(OFF)L</sub>	Current Turn-Off Delay Time-Inductive
Current Fall Time–Inductive		15	2.8	-		$V_{GE}$ = 5 V, $R_{G}$ = 470 $\Omega$ $I_{CE}$ = 6.5 A, $T_{J}$ = 25°C		Current Fall Time-Inductive

#### PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Diameter	Tape Width	Qty
ISL9V3040G1	ISL9V3040D3STV	DPAK (Pb-Free)	330 mm	16 mm	2500

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **TYPICAL CHARACTERISTICS**

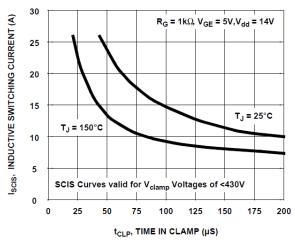


Figure 1. Self Clamped Inductive Switching Current vs. Time in Clamp

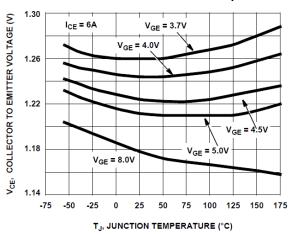


Figure 3. Collector to Emitter On–State Voltage vs. Junction Temperature

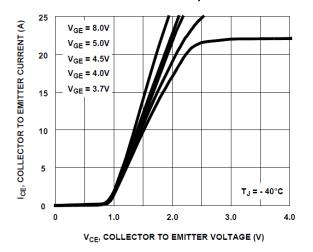


Figure 5. Collector to Emitter On–State Voltage vs. Collector Current

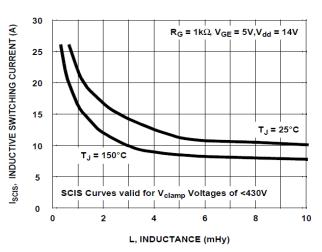


Figure 2. Self Clamped Inductive Switching Current vs. Inductance

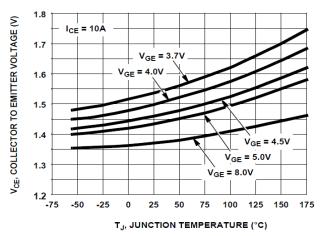


Figure 4. Collector to Emitter On-State Voltage vs. Junction Temperature

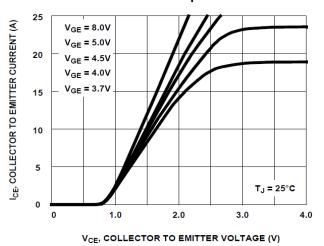


Figure 6. Collector to Emitter On- State Voltage vs. Collector Current

#### TYPICAL CHARACTERISTICS (continued)

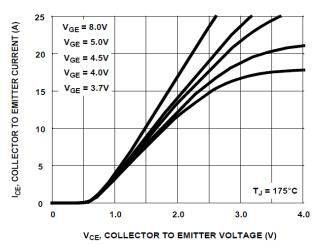


Figure 7. Collector to Emitter On–State Voltage vs. Collector Current

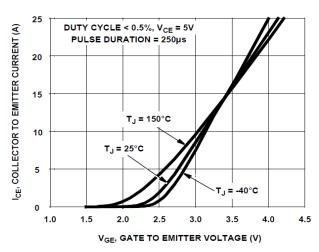


Figure 8. Transfer Characteristics

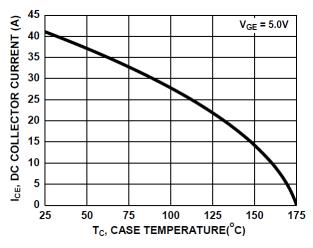


Figure 9. DC Collector Current vs. Case Temperature

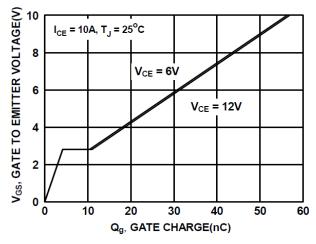


Figure 10. Gate Charge

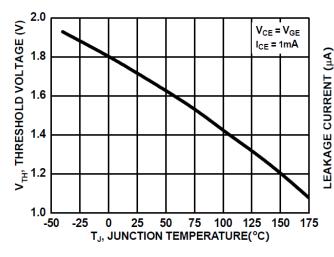


Figure 11. Threshold Voltage vs. Junction Temperature

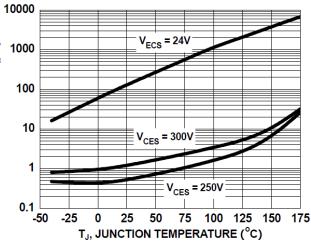


Figure 12. Leakage Current vs. Junction Temperature

#### TYPICAL CHARACTERISTICS (continued)

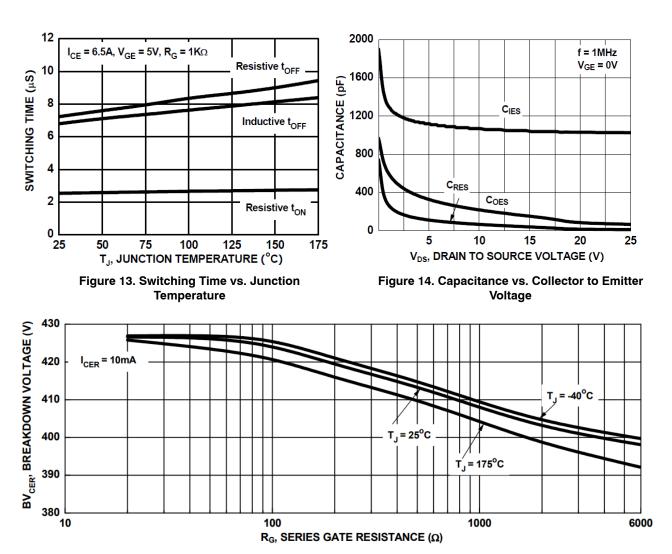


Figure 15. Break down Voltage vs. Series Resistance

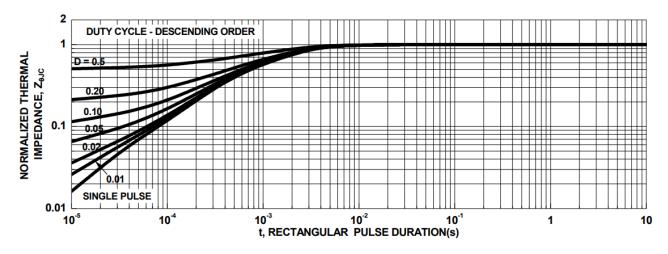
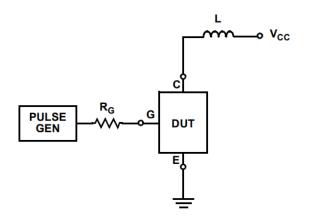


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case



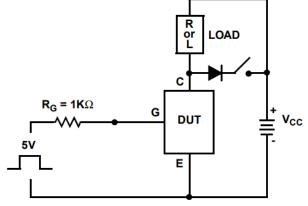


Figure 17. Inductive Switching Test Circuit

Figure 18.  $t_{\mbox{\scriptsize ON}}$  and  $t_{\mbox{\scriptsize OFF}}$  Switching Test Circuit

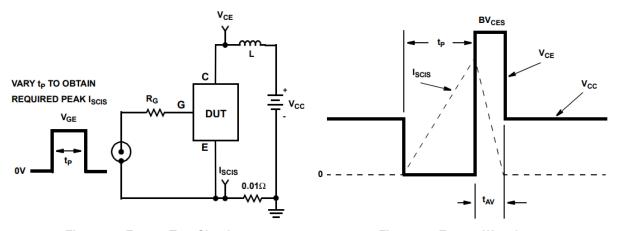
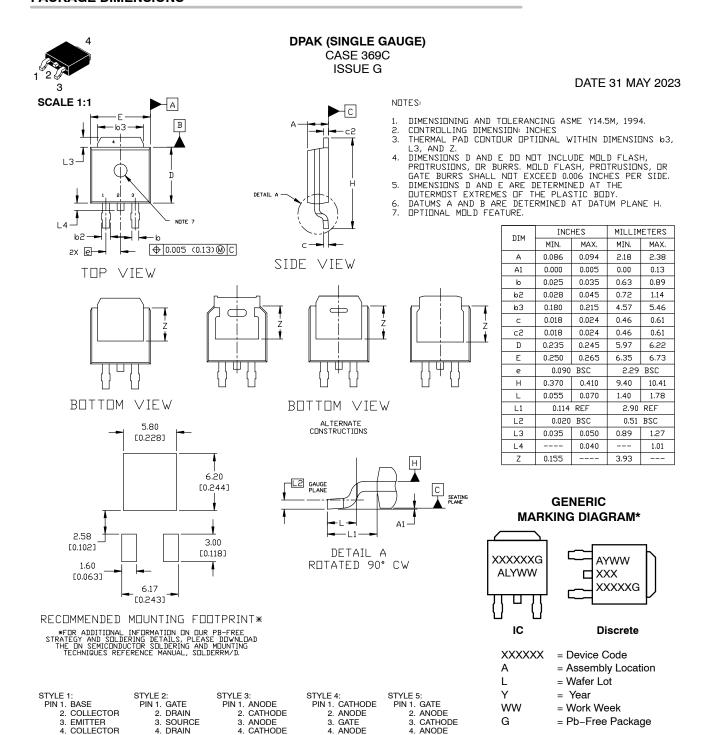


Figure 19. Energy Test Circuit

Figure 20. Energy Waveforms





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DESCRIPTION:	DPAK (SINGLE GAUGE)		PAGE 1 OF 1

STYLE 10:

PIN 1. CATHODE 2. ANODE

3 CATHODE

4. ANODE

STYLE 9:

PIN 1. ANODE 2. CATHODE

3 RESISTOR ADJUST

CATHODE

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STYLE 7: PIN 1. GATE 2. COLLECTOR

3 FMITTER

4. COLLECTOR

STYLE 8:

PIN 1. N/C 2. CATHODE

3 ANODE

CATHODE

STYLE 6:

PIN 1. MT1 2. MT2

3 GATE

\*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot "=", may

or may not be present. Some products may

not follow the Generic Marking.

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